

**AMENDMENT TO THE SPECIFICATION**

Please replace paragraph [0044] with the following amended paragraph:

[0044] FIG. 8 is a perspective view of another exemplary connection portion between a touch panel device and a flexible printed circuit film according to the present invention. In FIG. 8, a touch panel device 51 may include a signal line 33 connected to external components formed along one side thereof, an adhesion part [[45]] (not shown) where one end of the signal line 33 may be bonded to an FPC 17, a cover shield [[54]] (not shown) bonded to an entire surface of a PCB 6a of a display panel, and an adhesion-reinforcing part [[42]] (not shown) having the cover shield [[54]] and the PCB 6a to prevent an external force [[35]] from being applied directly to the adhesion part [[45]] (not shown). Since the structure of the touch panel device 51 may be the same as the structure shown in FIGs. 5 and 6, descriptions of the touch panel will be omitted.

Please replace paragraph [0045] with the following amended paragraph:

[0045] FIG. 9 is an enlarged plan view of another exemplary connection portion between a touch panel device and a flexible printed circuit film according to the present invention. In FIG. 9, a signal line 33 may be formed having a similar pattern to a line pattern of a FPC 17. In an adhesion part 45, the FPC 17 may be mounted on an adhesive [[38]] (not shown) spread on one end of the signal line 33 to electrically interconnect the touch panel device 51 with the FPC 17. The adhesion part 45 of the signal line 33 and the FPC 17 may be bonded for a line pattern of the FPC 17 to coincide with the signal line 33 pattern of the touch panel device 51.

Please replace paragraph [0049] with the following amended paragraph:

[0049] FIG. 11 is a plan view of another exemplary connection portion between a touch panel device and a flexible printed circuit film according to the present invention. In FIG. 11, a touch panel 51 may include a signal line [[33]] (not shown) connected to an exterior along one side thereof, an adhesion part 45 where one end of the signal line [[33]] may be bonded to a FPC 17, an adhesion-reinforcing part [[42]] (not shown) formed on the adhesion part 45 to prevent an external force 35 from being applied directly to the adhesion part 45 after the FPC 17 is bonded to the one end of the signal line [[33]], and a solder portion 64 extending through the FPC 17 from the adhesion-reinforcing part [[42]] to contact the signal line [[33]]. Since the structure of the touch panel device 51 in FIG. 11 may be similar to the structure of FIGs. 5 and 6, a description of the touch panel will be omitted.

Please replace paragraph [0051] with the following amended paragraph:

[0051] The adhesion-reinforcing part [[42]] (not shown) may include the solder portion 64 passing through the FPC 17 on the adhesion part 45. Since the solder portion 64 passes through the FPC 17 to contact the signal line 33, the adhesive bonding strength between the FPC 17 and the signal line 33 may increase and the conductivity between the touch controller 4 and the touch panel device 51 may also increase. Accordingly, the touch panel device may include the adhesion-reinforcing part [[42]] with the solder portion 64, and may absorb a specific portion of any external force 35 applied to the adhesion part 45. Thus, the touch panel device 51 may increase the adhesive bonding strength between the FPC 17

and the touch panel device 51 by widening an adhesive bonding area, thereby improving the stability of the touch panel device 51 to reduce the generation of defects the touch panel.